



# Mini Family 28V Wide Input

G SUS C TTV ROHS C E

# **DC-DC Converter Module**

#### **Features & Benefits**

DC input range: 9 – 36V [a]

Isolated output

Input surge withstand: 50V for 100ms

DC output: 3.3 – 48V

Programmable output: 10 – 110%

· Regulation: ±0.2% no load to full load

 Maximum operating temp: 100°C, full load

Power density: up to 60W per cubic inch

Height above board: 0.43in [10,9mm]

Parallelable, with N+M fault tolerance

• Low-noise ZCS/ZVS architecture

RoHS Compliant (with F or G pin option)

#### **Product Overview**

These DC-DC converter modules use advanced power processing, control and packaging technologies to provide the performance, flexibility, reliability and cost effectiveness of a mature power component.

High-frequency ZCS/ZVS switching provides high power density with low noise and high efficiency.

# **Applications**

Industrial and process control, distributed power, medical, ATE, communications, defense and aerospace.

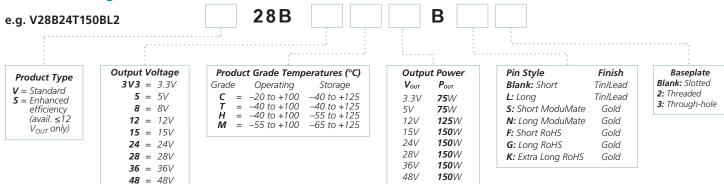
For details on proper operation please refer to the:

<u>Design Guide & Applications Manual for Maxi, Mini, Micro Family.</u>

#### **Absolute Maximum Ratings**

Parameter	Rating	Unit	Notes
+IN to –IN voltage	-0.5 to +53	$V_{DC}$	
PC to –IN voltage	-0.5 to +7.0	$V_{DC}$	
PR to –IN voltage	-0.5 to +7.0	$V_{DC}$	
SC to –OUT voltage	-0.5 to +1.5	$V_{DC}$	
–Sense to –OUT voltage	1.0	$V_{DC}$	
lsolation voltage IN to OUT	3000	$V_{RMS}$	Test voltage
IN to base	1500	$V_{RMS}$	Test voltage
OUT to base	500	$V_{RMS}$	Test voltage
Operating Temperature	-55 to +100	°C	M-Grade
Storage Temperature	-65 to +125	°C	M-Grade
Din coldoring tomporature	500 [260]	°F [°C]	<5 sec; wave solder
Pin soldering temperature	750 [390]	°F [°C]	<7 sec; hand solder
Mounting torque	5 [0.57]	in∙lbs [N·m]	6 each

# **Part Numbering**



Note: Product images may not highlight current product markings.



<sup>[</sup>a] Derate power to 75% for  $9 - 10V_{IN}$ .

# **Module Family Electrical Characteristics**

Electrical characteristics apply over the full operating range of input voltage, output load (resistive) and baseplate temperature, unless otherwise specified. All temperatures refer to the operating temperature at the center of the baseplate.

#### **Module Input Specifications**

Parameter	Min	Тур	Max	Unit	Notes
Operating input voltage	9	24	36	$V_{DC}$	From 9 to 10V input available power is reduced to 75% of max rating.
Input surge withstand			50	V <sub>DC</sub>	<100ms
Undervoltage turn-on		8.73	8.95	V <sub>DC</sub>	
Undervoltage turn-off	7.37	7.64		$V_{DC}$	
Overvoltage turn-off/on	36.3	37.8	39.6	V <sub>DC</sub>	
Disabled input current		12.0	14.0	mA	PC pin low

#### **Module Output Specifications**

Parameter	Min	Тур	Max	Unit	Notes
Output voltage set point			±1	%	Of nominal output voltage. Nominal input; full load; 25%
Line regulation		±0.02	±0.20	%	Low line to high line; full load
Temperature regulation		±0.002	±0.005	%/°C	Over operating temperature range
Power sharing accuracy		±2	±5	%	10 – 100% of full load
Programming range	10		110	%	Of nominal output voltage. For trimming below 90% of nominal, a minimum load of 10% of maximum rated power may be required.
+OUT to -OUT, +Sense to -Ol	JT — Absolute Ma	ximum Ratings	<u>5</u>		
3.3V			-0.5 to 4.7	$V_{DC}$	Externally applied
5V			-0.5 to 7.0	$V_{DC}$	Externally applied
12V			–0.5 to 16.1	$V_{DC}$	Externally applied
15V			-0.5 to 20.0	$V_{DC}$	Externally applied
24V			–0.5 to 31.7	V <sub>DC</sub>	Externally applied
28V			-0.5 to 36.9	$V_{DC}$	Externally applied
36V			-0.5 to 47.1	V <sub>DC</sub>	Externally applied
48V			-0.5 to 62.9	V <sub>DC</sub>	Externally applied

**Note:** The permissible load current must never be exceeded during normal, abnormal or test conditions. For additional output related application information, please refer to output connections on page 6.

# **Thermal Resistance and Capacity**

Parameter	Min	Тур	Max	Unit	
Baseplate to sink; flat, greased surface		0.16		°C/Watt	
Baseplate to sink; thermal pad (P/N 20264)		0.14		°C/Watt	
Baseplate to ambient		8.0		°C/Watt	
Baseplate to ambient; 1000LFM		1.9		°C/Watt	
Thermal capacity		83		Watt-sec/°C	



# **Module Family Electrical Characteristics (Cont.)**

Electrical characteristics apply over the full operating range of input voltage, output load (resistive) and baseplate temperature, unless otherwise specified. All temperatures refer to the operating temperature at the center of the baseplate.

#### **Module Control Specifications**

Parameter	Min	Тур	Max	Unit	Notes
Primary Side (PC = Primary Co	ontrol; PR = Paralle	el)			
PC bias voltage current limit	5.50 1.5	5.75 2.1	6.00 3.0	V <sub>DC</sub> mA	PC current = 1.0mA PC voltage = 5.5V  During normal operation
PC module disable	2.3	2.6	2.9	V <sub>DC</sub>	Switch must be able to sink ≥4mA. See Figure 2
PC module enable delay		4	7	ms	
PC module alarm			0.5	$V_{AVG}$	UV, OV, OT, module fault. See Figures 3 and 5
PC resistance	0.9	1.0	1.1	ΜΩ	See Figure 3, converter off or fault mode
PR emitter amplitude	5.7	5.9	6.1	Volts	PR load >30Ω, <30pF
PR emitter current	150			mA	
PR receiver impedance	375	500	625	Ω	25°C
PR receiver threshold	2.4	2.5	2.6	Volts	Minimum pulse width: 20ns
PR drive capability			12	modules	Without PR buffer amplifier
Secondary Side (SC = Second	ary Control)				
SC bandgap voltage	1.21	1.23	1.25	$V_{DC}$	Referenced to –Sense
SC resistance	990	1000	1010	Ω	
SC capacitance		0.033		μF	
SC module alarm		0		$V_{DC}$	With open trim; referenced to –Sense. See Figure 7

#### **Module General Specifications**

Parameter	Min	Тур	Max	Unit	Notes
Remote sense (total drop)			0.5	V <sub>DC</sub>	0.25V per leg (sense leads must be connected to respective, output terminals)
Isolation test voltage (IN to OUT)*	3000			$V_{RMS}$	Complies with reinforced insulation requirements
Isolation test voltage (IN to base)*	1500			$V_{RMS}$	Complies with basic insulation requirements
Isolation test voltage (OUT to base)*	500			V <sub>RMS</sub>	Complies with operational insulation requirements
Isolation resistance		10		ΜΩ	IN to OUT, IN to baseplate, OUT to baseplate
Weight (E, C, T grade)	3.1 [89.3]	3.5 [100.3]	3.9 [111.3]	ounces [grams]	
Weight (H, M grade)	3.5 [99.6]	3.9 [110.6]	4.3 [121.6]	ounces [grams]	
Temperature limiting	100	115		°C	See Figures 3 and 5. Do not operate coverter >100°C.
Agency approvals cURus, cTÜVus, CE				UL60950-1, EN60950-1, CSA60950-1, IEC60950-1. With appropriate fuse in series with the +Input	

<sup>\*</sup> Isolation test voltage, 1 minute or less.

Note: Specifications are subject to change without notice.



# **Module-Specific Operating Specifications**

# 3.3V<sub>OUT</sub>, 75W (e.g. S28B3V3C75BL, V28B3V3C75BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency					
S28B3V3C75BL (enhanced efficiency)	78.0	83.0		%	Nominal input; 75% load; 25°C
V28B3V3C75BL (standard efficiency)	76.7	77.7			
Ripple and noise		60	75	mV	P-P; Nominal input; full load; 20MHz bandwidth
Output OVP	4.14	4.3	4.46	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		5.2	5.8	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		22.73	Amps	For $V_{IN}$ 9 – 10V, load current 17.05A max.
Current limit	23.1	26.1	30.7	Amps	Output voltage 95% of nominal
Short circuit current	15.8	26.1	30.7	Amps	Output voltage <250mV

# 5V<sub>OUT</sub>, 75W (e.g. S28B5C75BL, V28B5C75BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency					
S28B5C75BL (enhanced efficiency)	75.0	79.0		%	Nominal input; 75% load; 25°C
V28B5C75BL (standard efficiency)	71.8	73.3			
Ripple and noise		252	315	mV	P-P; Nominal input; 75% load; 20MHz bandwidth
Output OVP set point	6.03	6.25	6.47	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		5.8	6.5	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		15	Amps	For V <sub>IN</sub> 9 – 10V, load current 11.25A max.
Current limit	15.3	17.3	20.3	Amps	Output voltage 95% of nominal
Short circuit current	10.5	17.3	20.3	Amps	Output voltage <250mV

# 12V<sub>OUT</sub>, 125W (e.g. S28B12C125BL, V28B12C125BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency					
S28B12C125BL (enhanced efficiency)	83.0	85.0		%	Nominal input; 75% load; 25°C
V28B12C125BL (standard efficiency)	79.3	80.8			
Ripple and noise		290	363	mV	P-P; Nominal input; full load; 20MHz bandwidth
Output OVP set point	13.7	14.3	14.9	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		8.2	9.4	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		10.4	Amps	For V <sub>IN</sub> 9 – 10V, load current 7.8A max.
Current limit	10.6	12.0	14.1	Amps	Output voltage 95% of nominal
Short circuit current	7.3	12.0	14.1	Amps	Output voltage <250mV

# 15V<sub>OUT</sub>, 150W (e.g. V28B15C150BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency	82.5	83.9		%	Nominal input; 75% load; 25°C
Ripple and noise		328	410	mV	P-P; Nominal input; full load; 20MHz bandwidth
Output OVP set point	17.1	17.8	18.5	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		6.8	7.8	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		10	Amps	For V <sub>IN</sub> 9 – 10V, load current 7.5A max.
Current limit	10.2	11.5	13.5	Amps	Output voltage 95% of nominal
Short circuit current	7	11.5	13.5	Amps	Output voltage <250mV



# **Module-Specific Operating Specifications (Cont.)**

# 24V<sub>OUT</sub>, 150W (e.g. V28B24C150BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency	78.5	81.0		%	Nominal input; 75% load; 25°C
Ripple and noise		448	560	mV	P-P; Nominal input; full load; 20MHz bandwidth
Output OVP set point	27.1	28.1	29.1	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		8.9	10.5	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		6.25	Amps	For V <sub>IN</sub> 9 – 10V, load current 4.69A max.
Current limit	6.37	7.19	9.2	Amps	Output voltage 95% of nominal
Short circuit current	4.37	7.19	9.2	Amps	Output voltage <250mV

# 28V<sub>OUT</sub>, 150W (e.g. V28B28C150BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency	79.4	80.9		%	Nominal input; 75% load; 25°C
Ripple and noise		360	450	mV	P-P; Nominal input; full load; 20MHz bandwidth
Output OVP set point	31.5	32.7	33.9	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		9.6	10.9	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		5.36	Amps	For V <sub>IN</sub> 9 – 10V, load current 4.02A max.
Current limit	5.46	6.16	7.24	Amps	Output voltage 95% of nominal
Short circuit current	3.75	6.16	7.24	Amps	Output voltage <250mV

# 36V<sub>OUT</sub>, 150W (e.g. V28B36C150BL)

Min	Тур	Max	Unit	Notes
78.8	79.8		%	Nominal input; 75% load; 25°C
	320	400	mV	P-P; Nominal input; full load; 20MHz bandwidth
40.4	41.9	43.4	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
	9	10	Watts	No load
	±0.02	±0.2	%	No load to full load; nominal input
0		4.17	Amps	For V <sub>IN</sub> 9 – 10V, load current 3.13A max.
4.25	4.8	5.63	Amps	Output voltage 95% of nominal
2.91	4.8	5.63	Amps	Output voltage <250mV
	78.8 40.4 0 4.25	78.8 79.8 320 40.4 41.9 9 ±0.02 0 4.25 4.8	78.8 79.8 320 400 40.4 41.9 43.4 9 10 ±0.02 ±0.2 0 4.17 4.25 4.8 5.63	78.8 79.8 % 320 400 mV 40.4 41.9 43.4 Volts 9 10 Watts ±0.02 ±0.2 % 0 4.17 Amps 4.25 4.8 5.63 Amps

# 48V<sub>OUT</sub>, 150W (e.g. V28B48C150BL)

Parameter	Min	Тур	Max	Unit	Notes
Efficiency	80.5	81.8		%	Nominal input; 75% load; 25°C
Ripple and noise		320	400	mV	P-P; Nominal input; full load; 20MHz bandwidth
Output OVP set point	53.7	55.7	57.7	Volts	25°C; recycle input voltage or PC to restart (>100ms off)
Dissipation, standby		5.6	14	Watts	No load
Load regulation		±0.02	±0.2	%	No load to full load; nominal input
Load current	0		3.13	Amps	For V <sub>IN</sub> 9 – 10V, load current 2.35A max.
Current limit	3.19	3.6	4.23	Amps	Output voltage 95% of nominal
Short circuit current	2.19	3.6	4.23	Amps	Output voltage <250mV



# **Basic Module Operation**

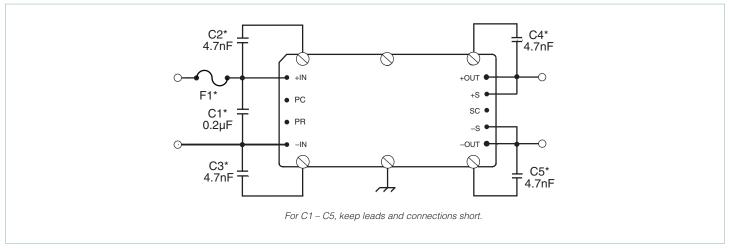


Figure 1 — Basic module operation requires fusing, grounding, bypassing capacitors.\* See Maxi, Mini, Micro Design Guide.

#### **Output Connections and Considerations**

The permissible load current must never be exceeded during normal, abnormal or test conditions. Converters subject to dynamic loading exceeding 25% of rated current must be reviewed by Vicor Applications Engineering to ensure that the converter will operate properly.

Under dynamic-load, light-load or no-load conditions, the converter may emit audible noise. Converters that utilize remote sense may require compensation circuitry to offset the phase lag caused by the external output leads and load impedance. Remote-Sense

leads must be protected for conditions such as lead reversal, noise pickup, open circuit or excessive output lead resistance between the sense point and the converters output terminals. For applications that may draw more than the rated current, a fast-acting electronic circuit breaker must be utilized to protect the converter. Under no circumstance should the rated current be exceeded. Utilizing or testing of current limit or short circuit current will damage the converter. Ensure that the total output capacitance connected to the converter does not exceed the limits on Page 16, "Maximum Output Capacitance", of the design guide.

#### **Comprehensive Online Application Information**



#### The Design Guide and Applications Manual includes:

- Application circuits
- Design requirements
- EMC considerations
- Current sharing in power arrays
- Thermal performance information
- Recommended soldering methods
- Accessory modules filtering, rectification, front-ends
- Mounting options
- · ...and more.

# CLICK HERE TO VIEW DESIGN GUIDE

Also at vicorpower.com

- PowerBench online configurators
- Over 20 Application Notes
- Online calculators thermal, trimming, hold-up
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# **Primary Control – PC Pin**

#### Module Enable/Disable

The module may be disabled by pulling PC to 0V (2.3V max) with respect to the –Input. This may be done with an open collector transistor, relay, or optocoupler. Converters may be disabled with a single transistor or relay either directly or via "OR'ing" diodes for two or more converters. See Figure 2.

#### **Primary Auxiliary Supply**

During normal operation only, the PC Pin can source 5.7V @ 1.5mA. In the example shown in Figure 4, PC powers a module enabled LED.

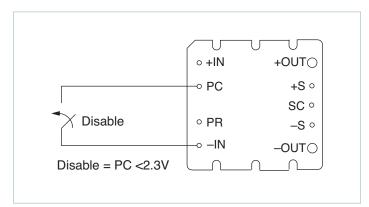


Figure 2 — Module enable/disable

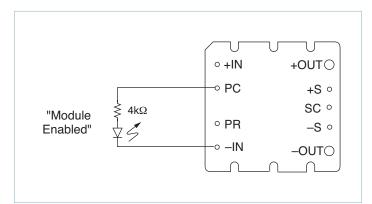


Figure 4 — LED on-state indicator

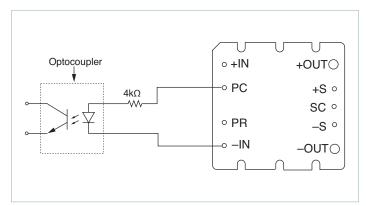


Figure 6 — Isolated on-state indicator

#### **Module Alarm**

The module contains "watchdog" circuitry which monitors input voltage, operating temperature and internal operating parameters. In the event that any of these parameters are outside of their allowable operating range, the module will shut down and PC will go low. PC will periodically go high and the module will check to see if the fault (as an example, Input Undervoltage) has cleared. If the fault has not been cleared, PC will go low again and the cycle will restart. The SC pin will go low in the event of a fault and return to its normal state after the fault has been cleared. See Figures 3 and 5.

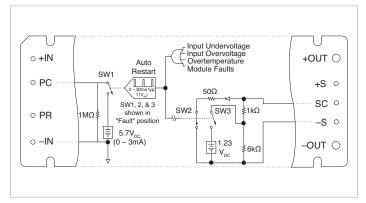


Figure 3 — PC/SC module alarm logic

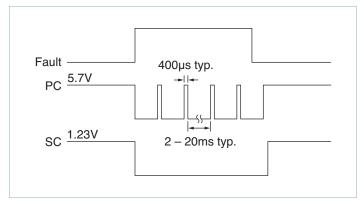


Figure 5 — PC/SC module alarm timing

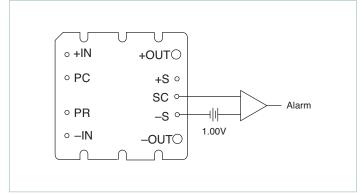


Figure 7 — Secondary-side on-state indicator

# Secondary Control - SC Pin

#### **Output Voltage Programming**

The output voltage of the converter can be adjusted or programmed via fixed resistors, potentiometers or voltage DACs. See Figure 8.

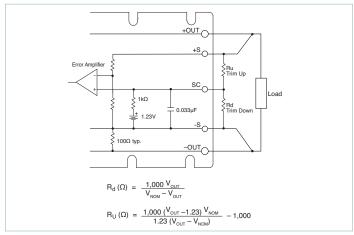


Figure 8 — Output voltage trim-down and trim-up circuit

#### **Trim Down**

- This converter is <u>not</u> a constant-power device it has a constant current limit. Hence, available output power is reduced by the same percentage that output voltage is trimmed down. Do not exceed maximum rated output current.
- 2. The trim-down resistor must be connected between the SC and –S pins. Do not bypass the SC pin directly with a capacitor.

#### **Trim Up**

- The converter is rated for a maximum delivered power. To ensure that maximum rated power is not exceeded, reduce maximum output current by the same percentage increase in output voltage.
- 2. The trim-up resistor must be connected between the SC and +S pins. Do not bypass the SC pin directly with a capacitor.
- 3. Do not trim the converter above maximum trim range (typically +10%) or the output over voltage protection circuitry may be activated.

#### Trim resistor values calculated automatically:

On-line calculators for trim resistor values are available on the vicor website at:

asp.vicorpower.com/calculators/calculators.asp?calc=1

Resistor values can be calculated for fixed trim up, fixed trim down and for variable trim up or down.

# Parallel Bus - PR Pin

#### **Parallel Operation**

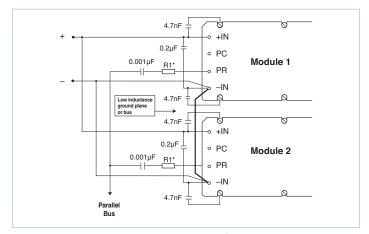
The PR pin supports paralleling for increased power with N+1 (N+M) redundancy. Modules of the same input voltage, output voltage, and power level will current share if all PR pins are suitably interfaced.

#### Compatible interface architectures include the following:

AC-coupled single-wire interface. All PR pins are connected to a single communication bus through  $0.001\mu F$  (500V) capacitors. This interface supports current sharing and is fault tolerant except for the communication bus. Up to three converters may be paralleled by this method. See Figure 9.

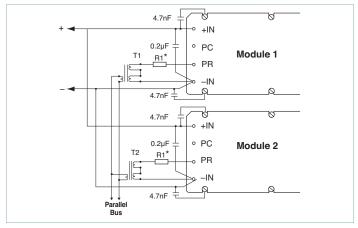
*Transformer-coupled interface.* For paralleling four or more converters a transformer-coupled interface is required, and under certain conditions a PR buffer circuit.

For details on parallel operation please refer to the Design Guide & Applications Manual for Maxi, Mini, Micro Family.



**Figure 9** — AC-coupled single-wire interface

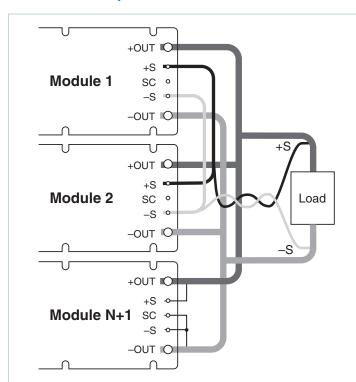
\* See Maxi, Mini, Micro Design Guide



**Figure 10** — Transformer-coupled interface

Number of Converters in Parallel	*R1 value Ω
2	75
3	50
4	33
5 or more	refer to application note: <u>Designing High-Power Arrays</u> <u>using Maxi, Mini, Micro</u> <u>Family DC-DC Converters</u>

# **Parallel Bus Output**



- The +OUT and -OUT power buses should be designed to minimize and balance parasitic impedance from each module output to the load.
- The +Sense pins must be tied together to form a
   +Sense bus. This must be Kelvin connected to +OUT at a
   single point. The -Sense pins should be tied together to
   form a -Sense bus. This must be Kelvin connected to -OUT
   at a single point.
- At the discretion of the power system designer, a subset of all modules within an array may be configured as children by connecting SC to –S.
- OR'ing diodes may be inserted in series with the +OUT pins of each module to provide module output fault tolerance.
- The +Sense and –Sense leads should be routed in close proximity to each other on the printed circuit board. If wires are used to connect the converters on a PCB to an external load, the Sense leads should be twisted together to reduce noise pickup.

**Figure 11** — N+1 module array output connections

#### Pin Styles\*

Designator	Description	Finish	Notes
(None)	Short	Tin/Lead	Requires inboard mounting
L	Long	Tin/Lead	On-board mounting for 0.065in boards
S	Short ModuMate	Gold	SurfMate or inboard socket mounting
N	Long ModuMate	Gold	On-board socket mounting
F	Short RoHS	Gold	Select for RoHS-compliant inboard solder, socket or SurfMate mounting
G	Long RoHS	Gold	Select for RoHS-compliant onboard solder or socket mounting
K	Extra Long RoHS	Gold	Select for RoHS compliance onboard mounting for thicker PCBs (not intended for socket or Surfmate mounting)

<sup>\*</sup> Pin style designator follows the "B" after the output power and precedes the baseplate designator. Ex. V28B12T125B**N**2 — Long ModuMate Pins

#### **Storage**

Vicor products, when not installed in customer units, should be stored in ESD safe packaging in accordance with ANSI/ESD S20.20, "Protection of Electrical and Electronic Parts, Assemblies and Equipment" and should be maintained in a temperature controlled factory/ warehouse environment not exposed to outside elements controlled between the temperature ranges of 15°C and 38°C. Humidity shall not be condensing, no minimum humidity when stored in an ESD compliant package.



# **Mechanical Drawings**

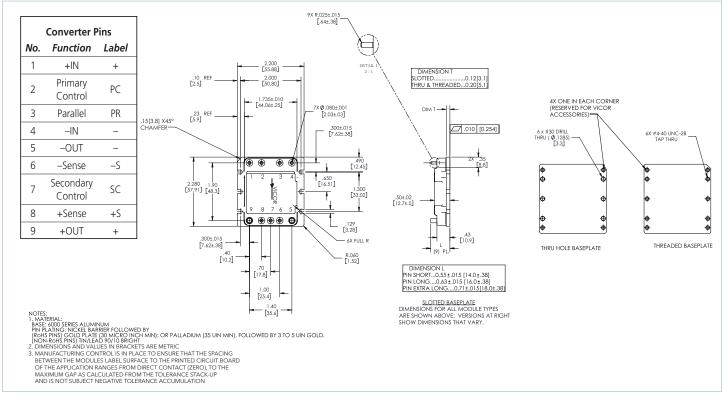


Figure 12 — Module outline

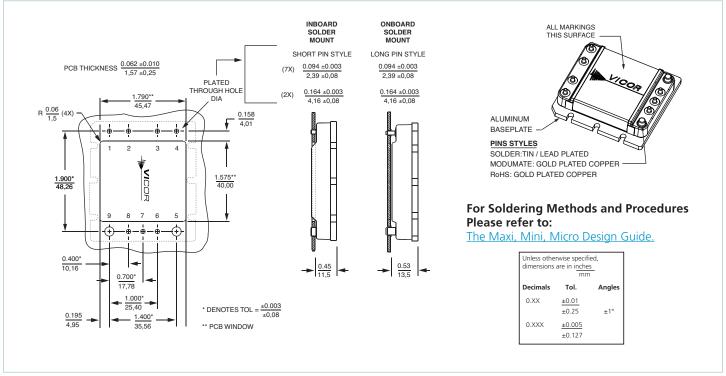


Figure 13 — PCB mounting specifications

# Vicor's comprehensive line of power solutions includes high density AC-DC and DC-DC modules and accessory components, fully configurable AC-DC and DC-DC power supplies, and complete custom power systems.

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Specifications are subject to change without notice.

Visit <a href="http://www.vicorpower.com/dc-dc-converters-board-mount/high-density-dc-dc-converters">http://www.vicorpower.com/dc-dc-converters-board-mount/high-density-dc-dc-converters</a> for the latest product information.

# **Vicor's Standard Terms and Conditions and Product Warranty**

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